



Designation: ~~F602–98a (Reapproved 2003)~~ Designation: F 602 – 09

Standard Criteria for Implantable Thermoset Epoxy Plastics¹

This standard is issued under the fixed designation F 602; the number immediately following the designation indicates the year of original adoption or, in the case of revision, the year of last revision. A number in parentheses indicates the year of last reapproval. A superscript epsilon (ϵ) indicates an editorial change since the last revision or reapproval.

1. Scope

1.1 These criteria cover thermoset plastics based on diglycidyl ethers of bisphenol A (DGEBA) and appropriate curing agents or catalysts as opposed to thermoplastics based on epoxy structures.

1.2 These criteria are generic and are intended to provide definitions and a standard description of epoxy plastics used in implantable devices. It is also intended to serve as a standard guide for the preparation of more specific documents with values and limits covering specific end uses.

1.3 Compliance with these criteria shall not be construed as an endorsement of implantability. The biocompatibility of epoxy plastics as a class has not been established. Epoxy plastic is a generic term relating to the class of polymers formed from epoxy resins, certain curing agents or catalysts, and various additives. Since many compositions and formulations fall under this class, it is essential that the formulator or fabricator ensure biocompatibility of the specific composition or formulation in its intended end use. Since these criteria provide guidance for the preparation of more specific documents covering specific end uses, these documents will provide bases for standardized evaluation of biocompatibility appropriate for a specific end use.

1.4 Each of the properties listed shall be considered in selecting materials for specific end uses. A list of selected properties with limiting values assigned is suggested for separate product specifications.

1.5 All of the properties and test methods listed may not be pertinent in any specific situation, nor may all of the tests outlined be required.

1.6 These criteria are limited to functionally or fully cured epoxy plastics. Uncured or incompletely cured formulations are specifically excluded.

1.7 The epoxy plastics covered by this standard are those to be evaluated for use in implantable biomedical devices. The term implantable is herein considered to include devices used in vivo for time periods in excess of 30 days.

1.8 *This standard does not purport to address all of the safety concerns, if any, associated with its use. It is the responsibility of the user of this standard to establish appropriate safety and health practices and determine the applicability of regulatory limitations prior to use.*

2. Referenced Documents

2.1 ASTM Standards:²

D 149 Test Method for Dielectric Breakdown Voltage and Dielectric Strength of Solid Electrical Insulating Materials at Commercial Power Frequencies

D 150 Test Methods for ϵ AC Loss Characteristics and Permittivity (Dielectric Constant) of Solid Electrical Insulating Materials²—Insulation

D 257 Test Methods for ϵ DC Resistance or Conductance of Insulating Materials

D 570 Test Method for Water Absorption of Plastics

D 621 Test Methods for Deformation of Plastics Under Load³

D 638 Test Method for Tensile Properties of Plastics

D 785 Test Method for Rockwell Hardness of Plastics and Electrical Insulating Materials

D 792 Test Methods for Density and Specific Gravity (Relative Density) of Plastics by Displacement

~~D 883 Terminology Relating to Plastics³~~

D 952 Test Method for Bond or Cohesive Strength of Sheet Plastics and Electrical Insulating Materials

¹ These criteria are under the jurisdiction of ASTM Committee F04 on Medical and Surgical Materials and Devices and are the direct responsibility of Subcommittee F04.11 on Polymeric Materials.

Current edition approved Apr. 10, 2003. Published May 2003. Originally approved in 1978. Last previous edition approved in 1998 as F602–98a.

Current edition approved Aug. 1, 2009. Published September 2009. Originally approved in 1978. Last previous edition approved in 2003 as F 602 – 98a(2003) .

² Annual Book of ASTM Standards, Vol 10.01.

³ For referenced ASTM standards, visit the ASTM website, www.astm.org, or contact ASTM Customer Service at service@astm.org. For Annual Book of ASTM Standards volume information, refer to the standard's Document Summary page on the ASTM website.

³ Withdrawn.

- D 1042 Test Method for Linear Dimensional Changes of Plastics Under Accelerated Service Conditions
- D 1434 Test Method for Determining Gas Permeability Characteristics of Plastic Film and Sheet
- D 1763 Specification for Epoxy Resins
- D 2393 Test Method for Viscosity of Epoxy Resins and Related Components⁰
- D 2471 ~~Test Method Practice~~ for Gel Time and Peak Exothermic Temperature of Reacting Thermosetting Resins
- D 2562 ~~Practice for Classifying Visual Defects in Parts Molded from Reinforced Thermosetting Plastics~~⁷
- ~~D 2566 Test Method for Linear Shrinkage of Cured Thermosetting Casting Resins During Cure~~ Practice for Classifying Visual Defects in Parts Molded from Reinforced Thermosetting Plastics
- D 2734 ~~Test Method for Void Content of Reinforced Plastics~~⁷
- ~~D 2990 Test Method for Tensile, Compressive, and Flexural Creep and Creep Rupture of Plastics~~⁷
- ~~D 3013 Specification for Epoxy Molding Compounds~~⁷ Test Methods for Void Content of Reinforced Plastics
- D 3137 Test Method for Rubber Property—Hydrolytic Stability
- E 96 96/E 96M Test Methods for Water Vapor Transmission of Materials
- F 74 Practice for Determining Hydrolytic Stability of Plastic Encapsulants for Electronic Devices⁰
- F 619 Practice for Extraction of Medical Plastics
- F 748 Practice for Selecting Generic Biological Test Methods for Materials and Devices
- 2.2 *AAMI Standard:*
- ~~EOS-D10/75 Standard for Ethylene Oxide Sterilization~~
- EOS-D 10/75 Standard for Ethylene Oxide Sterilization⁴
- 2.3 *ISO Standard:*
- ISO 10993 Biological Evaluation of Medical Devices⁵

3. Terminology

3.1 Definitions:

3.1.1 *accelerator*—an additive used to increase the rate of cure. An accelerator may also be a catalyst, or it may actually change composition and, therefore, not qualify as a catalyst.

3.1.2 *additive*—a chemical added to epoxy resins or hardeners to modify the handling characteristics or cured properties, or both, of the epoxy-hardener combination.

3.1.2.1 *diluent*—a chemical used in admixture to modify or enhance the properties of either or both the uncured or cured formulations. A primary use is to reduce the viscosity of the mixed system although other properties such as exotherm rate, stiffness, moisture absorption, and so forth, may be modified or enhanced also.

3.1.2.1.1 *nonreactive diluent*—a diluent not containing chemically reactive functional groups.

3.1.2.1.2 *reactive diluent*—a diluent that reacts chemically with the epoxy resin or hardener, or both, during cure.

3.1.2.2 *filler*—a relatively inert solid particulate material added to an epoxy formulation to modify its strength, permanence, working properties, or other qualities, or to lower costs.

3.1.3 *curing agent or hardener*—a compound normally used in a predetermined concentration to react chemically (copolymerize) by means of several different mechanisms (for example, condensation or addition polymerization) with or without heat or pressure in order to change its form from a liquid or fusible, friable, soluble solid to an infusible, insoluble solid having useful and desirable application or end-use properties.

3.1.3.1 *initiator*—an additive used to cause a thermosetting resin to react with itself (polymerize). Usually, these additives—used in relatively very small amounts—initiate homo-polymerization of the epoxy resin resulting in ether linkages.

NOTE 1—The term “catalyst” is frequently misused to denote any material added to a resin to cause a reaction to occur. This usage should be discouraged. The Society of Plastics Industries defines a catalyst as “a compound which alters the speed of a reaction without changing its original composition.”

3.1.4 *epoxy*—oxirane ring structures.

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3.1.4.1 *epoxy plastic*—thermoplastic or thermosetting plastics containing ether or hydroxyalkyl repeating units or both, resulting from the ring-opening reactions of lower molecular weight polyfunctional oxirane resins or compounds, with catalysts or with various polyfunctional acidic or basic coreactants.

3.1.4.2 *epoxy resin*—generally, any resin (liquid or solid) with a chemical structure at least difunctional in oxirane. Specifically for this standard, the diglycidyl ethers of bisphenol A or the equivalent. These compounds are defined as Grade 1 in Specification D 1763.

⁰ Discontinued; See 1994 *Annual Book of ASTM Standards*, Vol 08.01.

⁴ Available from the Association for the Advancement of Medical Instrumentation, 1901 N. Ft. Myer Dr., Suite 602, Arlington, VA 22209.

⁵ *Annual Book of ASTM Standards*, Vol 15.09.

⁵ Available from American National Standards Institute (ANSI), 25 W. 43rd St., 4th Floor, New York, NY 10036, <http://www.ansi.org>.

3.1.5 Terms Relating to Cure:

3.1.5.1 *cure, v*—to change the properties of a polymeric system into a final, more stable, usable condition by the use of heat, radiation, or reaction with chemical additives.

3.1.5.2 *cure cycle*—the schedule of time periods at specified conditions to which a reacting thermosetting material is subjected to reach a specified property level.

3.1.5.3 *cure time*—the interval of time from the start of reaction to the time at which specified properties of the reacting thermosetting composition are reached. For materials that react under the conditions of mixing, the start of reaction is the time of initial exposure to the conditions necessary for reaction to occur.

3.1.5.4 *functionally cured*—the term used to denote an epoxy plastic that has attained sufficient cure to achieve stable properties.

3.1.5.5 *fully cured*—the term used to denote total disappearance of epoxy groups as detected by infrared spectroscopy, or other equally sensitive physicochemical methods.

3.1.5.6 *one-component system*—a formulation based on an epoxy resin preblended with a heat, moisture, or otherwise activated curing agent or catalyst. The mixture is storable but cures under the appropriate activation conditions.

3.1.5.7 *postcure*—the additional and separate curing operations to which a “hardened” thermosetting plastic composition is subjected in order to enhance one or more properties. Also used to ensure stabilization of physical properties under use conditions.

3.1.5.8 *two-component system*—a formulation based on an epoxy resin to which a curing agent or catalyst is added just prior to use.

4. Chemical Composition

4.1 *Epoxy Resins*—Oxirane-terminated reaction products of epichlorohydrin and bisphenol A (DGEBA) or the equivalent.

4.2 *Reactive Diluents*—The following are examples of compounds that may be included as reactive diluents:

4.2.1 Butyl glycidyl ether (BGE).

4.2.2 Phenyl glycidyl ether (PGE).

4.3 *Nonreactive Diluents*—The following are examples of compounds that may be included as nonreactive diluents:

4.3.1 Phthalate esters.

4.3.2 Nonyl phenols.

4.3.3 Miscible polymers.

4.3.4 Flexibilizers.

4.4 *Fillers*—The following are examples of fillers that may be incorporated in the formulations:

4.4.1 Silicas:

4.4.1.1 Fumed silica.

4.4.1.2 Precipitated hydrated silica.

4.4.1.3 Diatomaceous earth.

4.4.2 Carbons.

4.4.3 Certain radiopaque materials:

4.4.3.1 Certain inorganic nonmetallic particles.

4.4.3.2 Certain metallic particles.

4.4.4 Certain pigments.

4.4.5 Glass fibers.

4.4.6 Glass ceramic particles.

4.4.7 Glass or plastic microballoons.

4.5 *Other Additives*—The following are examples of additives that may be used in the formulation:

4.5.1 Slip agents.

4.5.2 Optical brighteners.

4.5.3 Surfactants.

4.6 *Curing Agents*—The following are examples of curing agents for epoxy resins:

4.6.1 Amines (primary, secondary, and tertiary) such as triethylenetetramine (TETA).

4.6.2 Anhydrides, such as phthalic anhydride.

4.6.3 Acids such as phthalic acid.

4.6.4 Amine-terminated polyamides.

4.6.5 Acid or amine-terminated telomers.

4.6.6 Schiff's bases.

4.7 *Catalysts*:

4.7.1 Lewis bases such as tertiary amines.

4.7.2 Lewis acids such as BF_3 .

4.8 *Accelerators*:

4.8.1 Tertiary amines.

4.8.2 Phenols.